

- **High-Performance Operation:**
Propagation Delay . . . 15 ns Max
- **Power-Up Clear on Registered Devices (All Register Outputs are Set High, but Voltage Levels at the Output Pins Go Low)**
- **Package Options Include Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Ceramic (J) 300-mil DIPs**
- **Dependable Texas Instruments Quality and Reliability**

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORTS
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

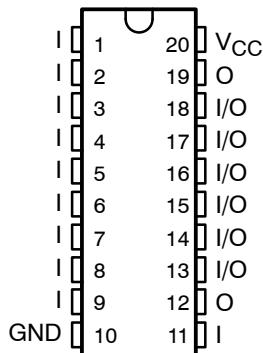
description

These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT-X™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

The TIBPAL16' M series is characterized for operation over the full military temperature range of -55°C to 125°C.

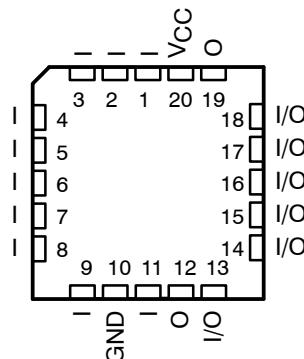
TIBPAL16L8'
J OR W PACKAGE

(TOP VIEW)



TIBPAL16L8'
FK PACKAGE

(TOP VIEW)



Pin assignments in operating mode

IMPORTANT PROGRAMMING NOTE: For TIBPAL16L8-15M devices in J, W, or FK packages – For date code 9903A or later device programming, select from either **TI Military/16L8-12** or **TI commercial TI/16L8-10** on the Manufacturer/Device menu listing in your programming system.

IMPORTANT PROGRAMMING NOTE: For TIBPAL16R4-15M devices in J, W, or FK packages – For date code 9616A or later device programming, select from either **TI Military/16R4-12** or **TI commercial TI/16R4-10** on the Manufacturer/Device menu listing in your programming system.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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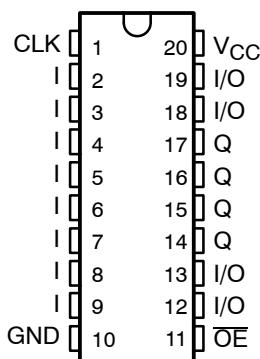
TIBPAL16L8-15M, TIBPAL16R4-15M

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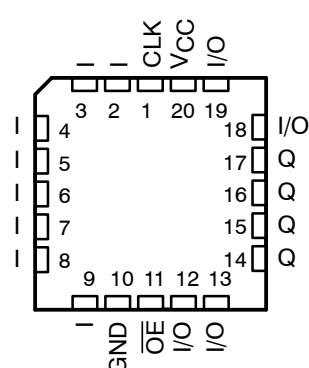
TIBPAL16R4'
J OR W PACKAGE

(TOP VIEW)



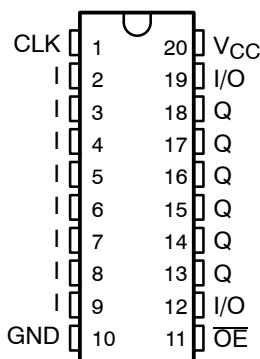
TIBPAL16R4'
FK PACKAGE

(TOP VIEW)



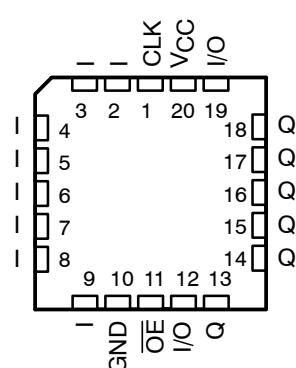
TIBPAL16R6'
J OR W PACKAGE

(TOP VIEW)



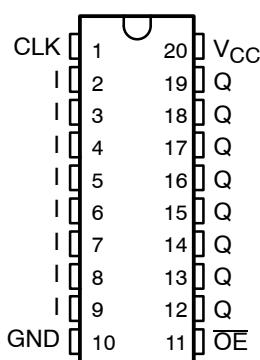
TIBPAL16R6'
FK PACKAGE

(TOP VIEW)



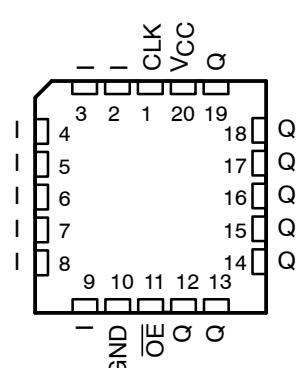
TIBPAL16R8'
J OR W PACKAGE

(TOP VIEW)



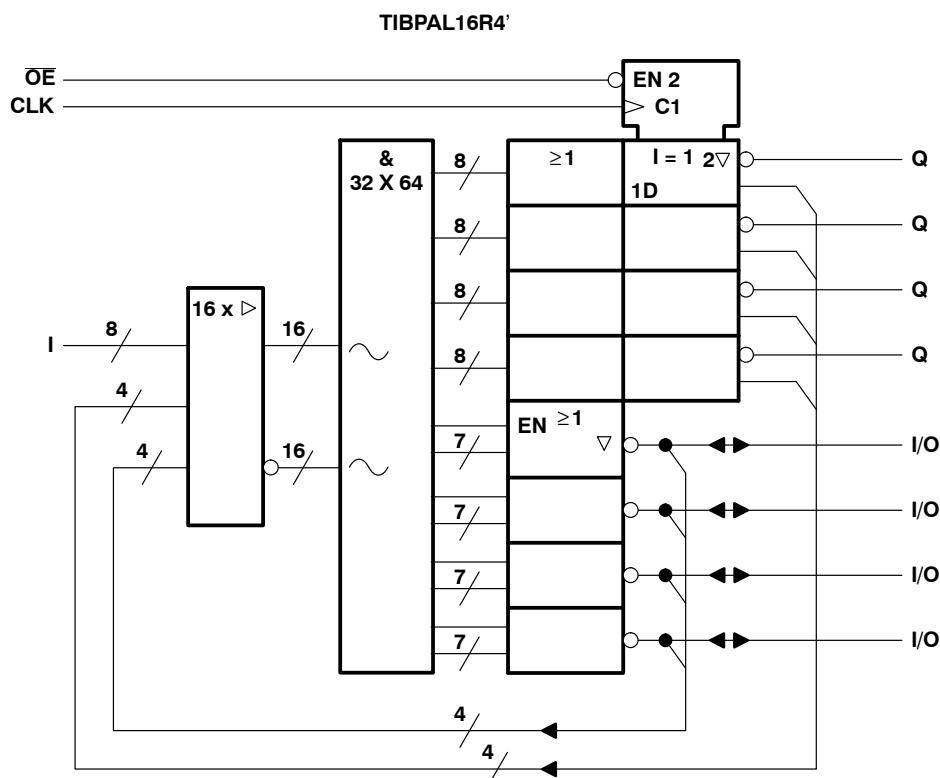
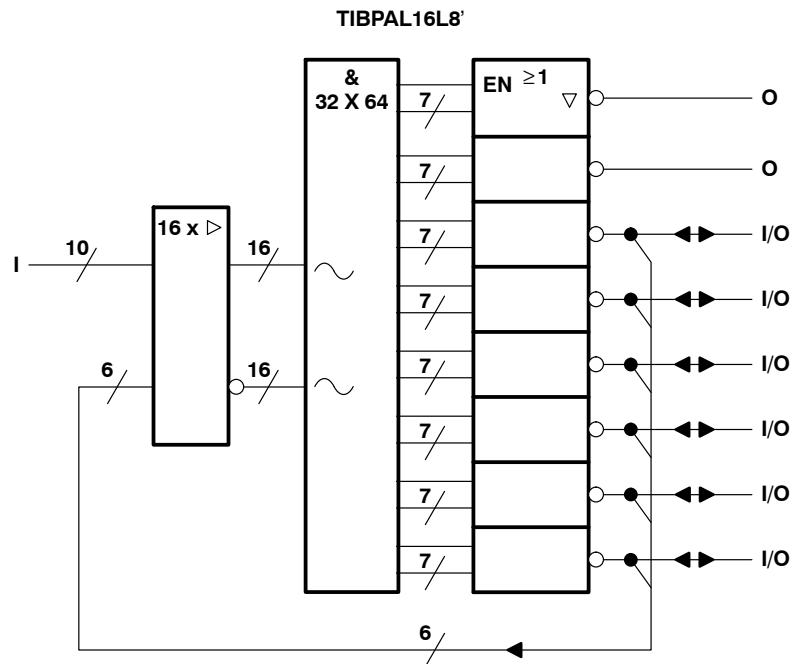
TIBPAL16R8'
FK PACKAGE

(TOP VIEW)



Pin assignments in operating mode

functional block diagrams (positive logic)



~ denotes fused inputs

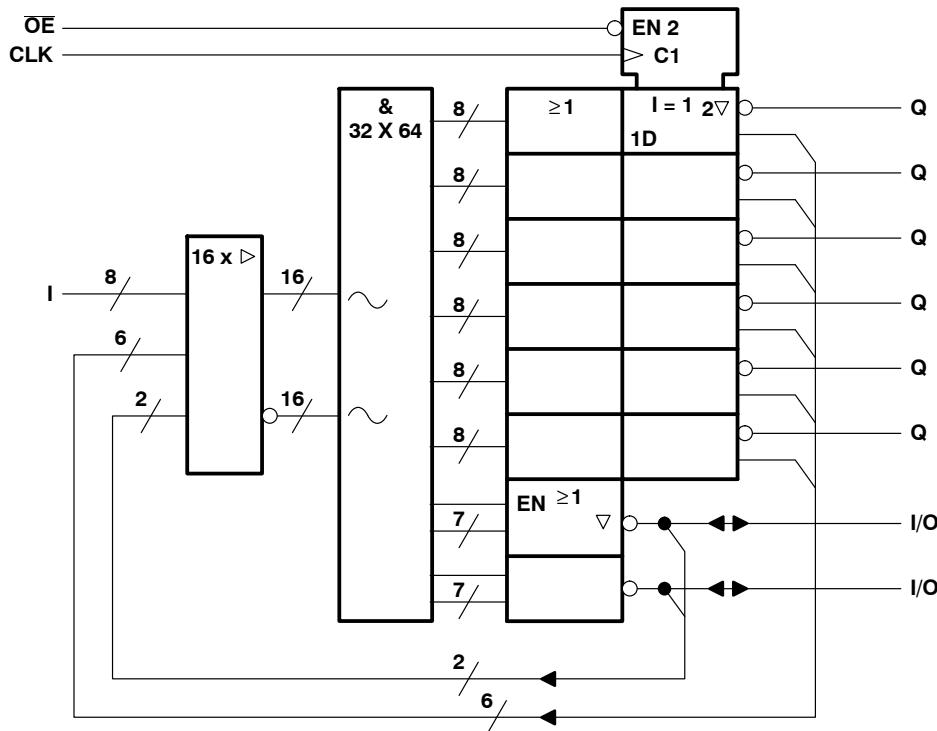
TIBPAL16L8-15M, TIBPAL16R4-15M

HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS

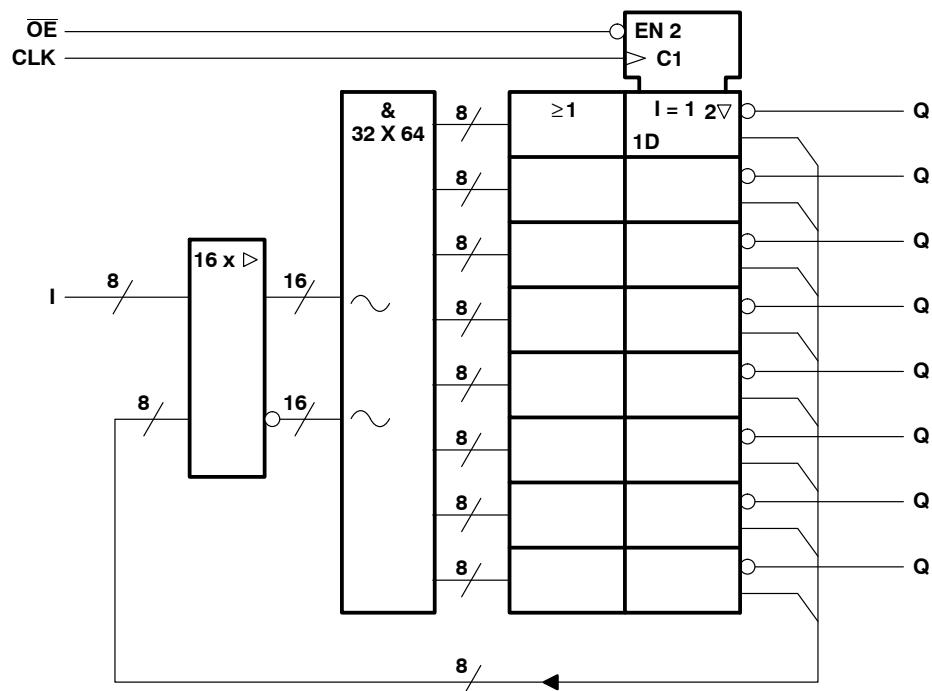
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functional block diagrams (positive logic)

TIBPAL16R6'

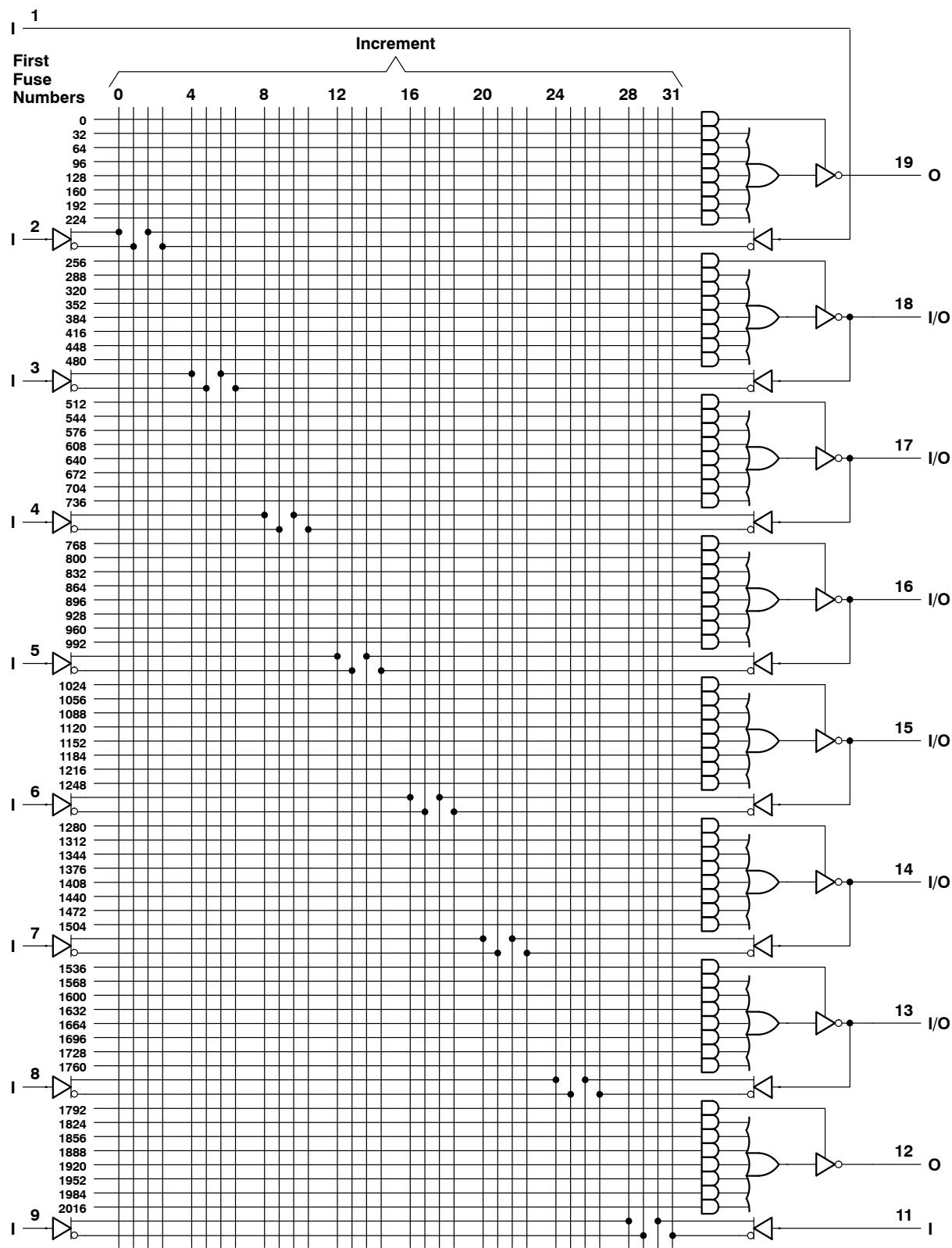


TIBPAL16R8'



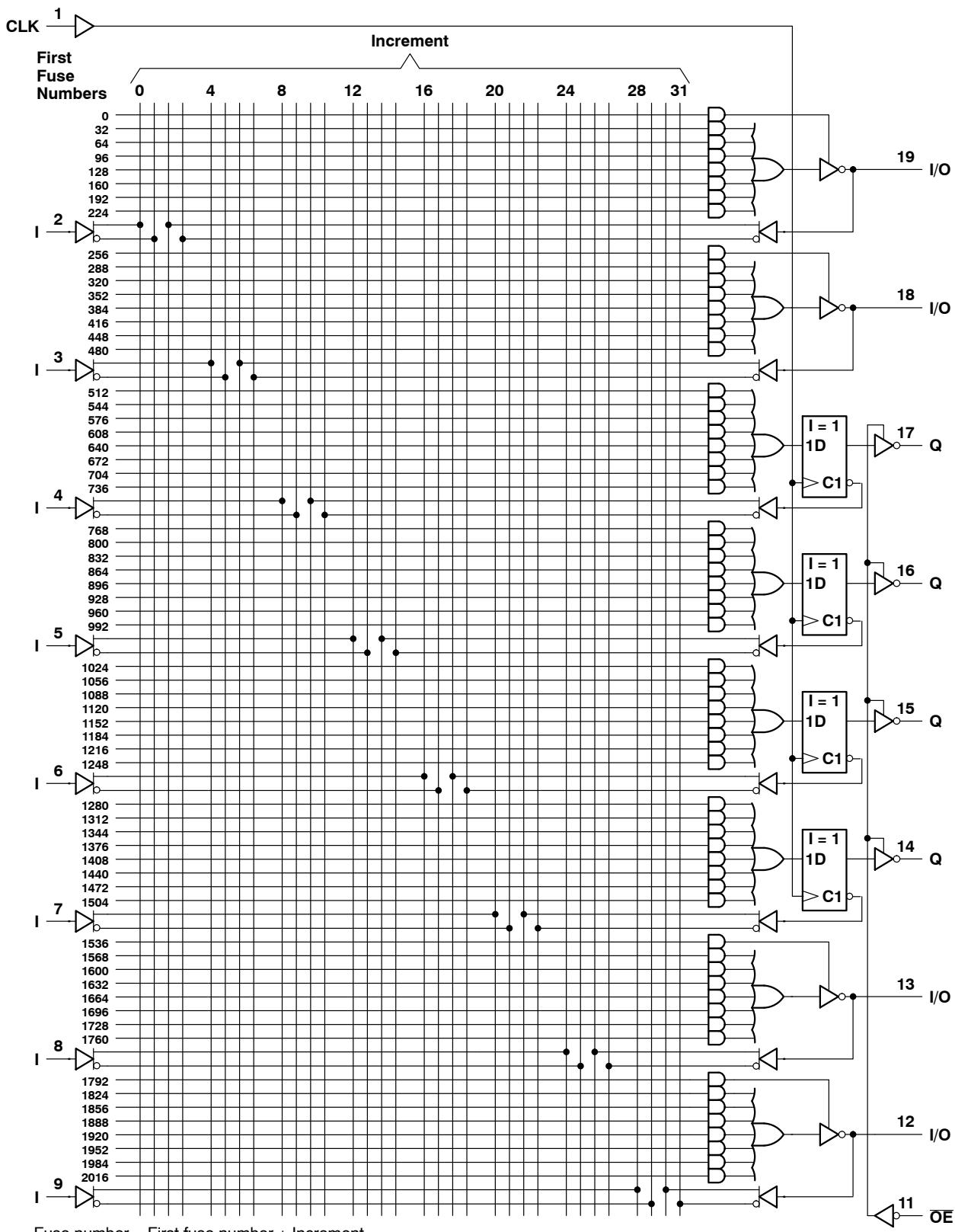
~ denotes fused inputs

TIBPAL16L8-15M logic diagram (positive logic)

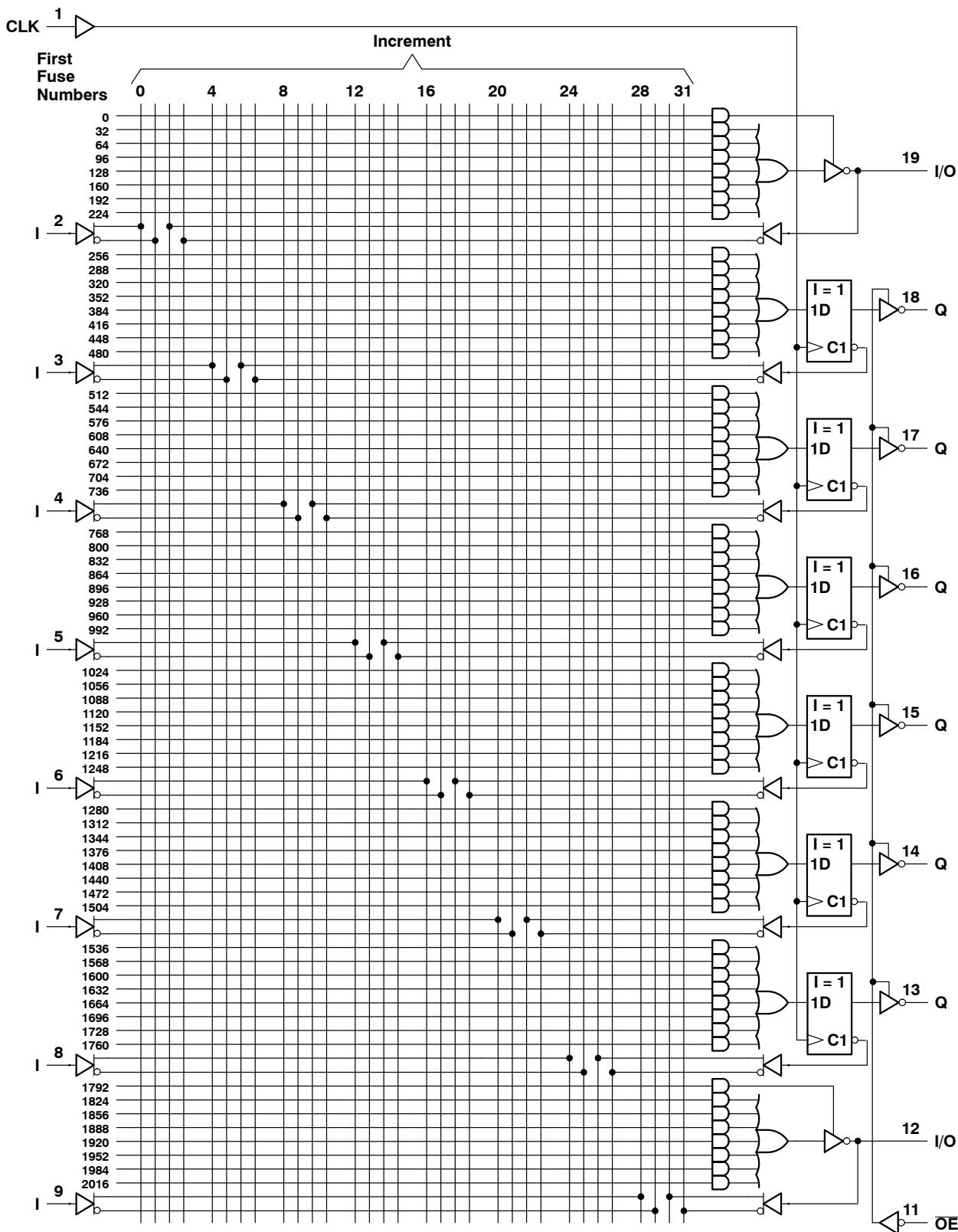


TIBPAL16L8-15M, TIBPAL16R4-15M
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TIBPAL16R4-15M logic diagram (positive logic)

TIBPAL16R6-15M logic diagram (positive logic)

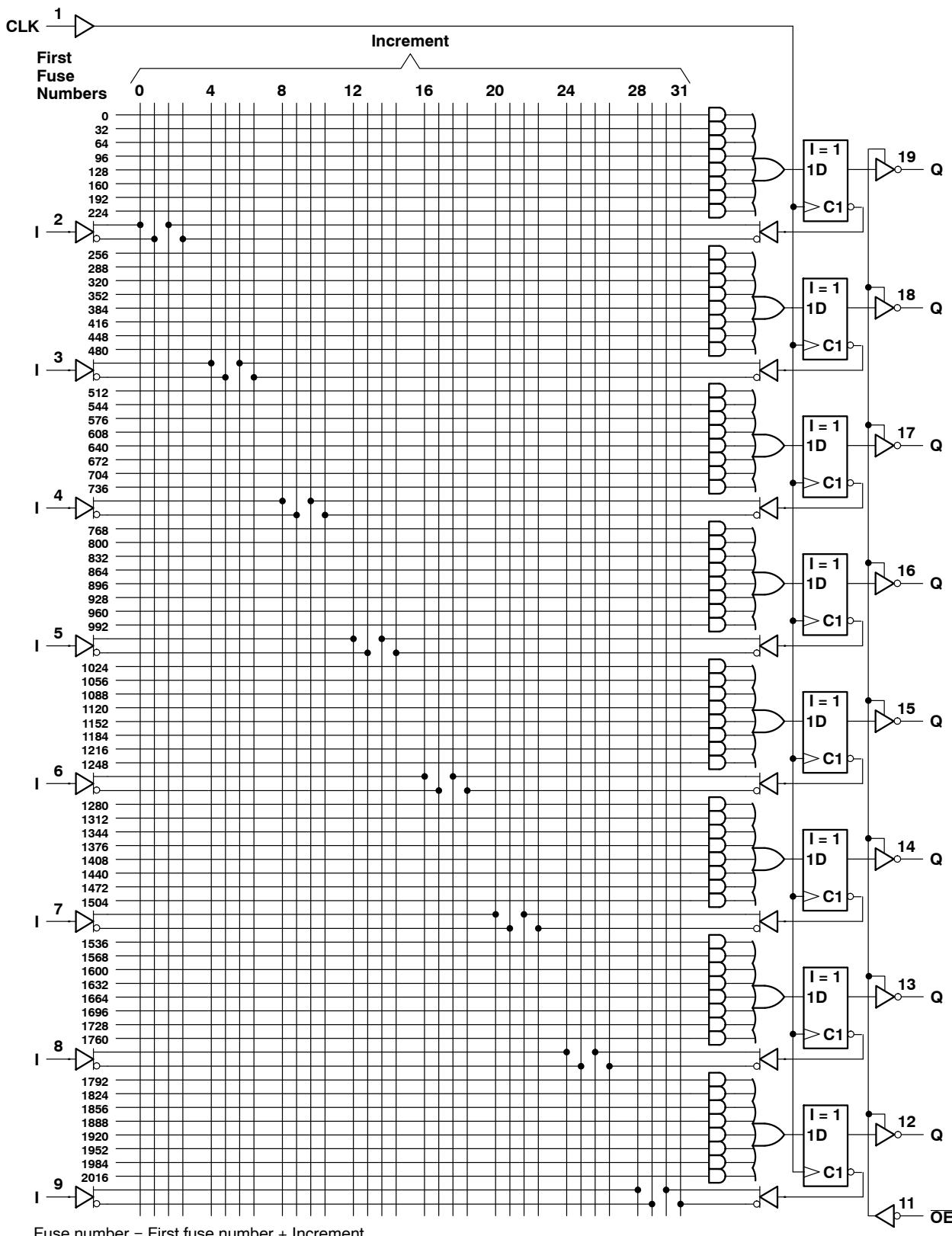


TIBPAL16L8-15M, TIBPAL16R4-15M

HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS

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TIBPAL16R8-15M logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	-55°C to 125°C
Storage temperature range	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2	5.5		V
V_{IL}	Low-level input voltage		0.8		V
I_{OH}	High-level output current		-2		mA
I_{OL}	Low-level output current		12		mA
f_{clock}	Clock frequency	0	50		MHz
t_w	Pulse duration, clock (see Note 2)	High	9		ns
		Low	10		
t_{su}	Setup time, input or feedback before clock↑	15			ns
t_h	Hold time, input or feedback after clock↑	0			ns
T_A	Operating free-air temperature	-55	25	125	°C

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock} . The minimum pulse durations specified are only for clock high or low, but not for both simultaneously.

electrical characteristics over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS	TIBPAL16R4-15M			UNIT
		MIN	TYP [‡]	MAX	
V_{IK}	$V_{CC} = 4.5$ V, $I_I = -18$ mA			-1.5	V
V_{OH}	$V_{CC} = 4.5$ V, $I_{OH} = -2$ mA	2.4	3.3		V
V_{OL}	$V_{CC} = 4.5$ V, $I_{OL} = 12$ mA		0.35	0.5	V
I_{OZH}	$V_{CC} = 5.5$ V, $V_O = 2.7$ V		20		µA
			100		
I_{OZL}	$V_{CC} = 5.5$ V, $V_O = 0.4$ V		-20		µA
			-250		
I_I	$V_{CC} = 5.5$ V, $V_I = 5.5$ V	0.2			mA
		0.1			
I_{IH}	$V_{CC} = 5.5$ V, $V_I = 2.7$ V	50			µA
		100			
		25			
I_{IL}	$V_{CC} = 5.5$ V, $V_I = 0.4$ V		-0.25		mA
$I_{OS}^§$	$V_{CC} = 5.5$ V, $V_O = 0.5$ V	-30	-250		mA
I_{CC}	$V_{CC} = 5.5$ V, $V_I = 0$, Outputs open	170	220		mA

‡ All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.

TIBPAL16L8-15M, TIBPAL16R4-15M
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electrical characteristics over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS	TIBPAL16L8-15M			UNIT
		MIN	TYP [†]	MAX	
V _{IK}	V _{CC} = 4.5 V, I _I = -18 mA		-1.5		V
V _{OH}	V _{CC} = 4.5 V, I _{OH} = -2 mA	2.4	3.3		V
V _{OL}	V _{CC} = 4.5 V, I _{OL} = 12 mA	0.35	0.5		V
I _{OZH}	Outputs		20		μA
	I/O ports	V _{CC} = 5.5 V, V _O = 2.7 V	100		
I _{OZL}	Outputs		-20		μA
	I/O ports	V _{CC} = 5.5 V, V _O = 0.4 V	-250		
I _I	Pin 1, 11		0.2		mA
	All others	V _{CC} = 5.5 V, V _I = 5.5 V	0.1		
I _{IH}	Pin 1, 11		50		μA
	I/O ports	V _{CC} = 5.5 V, V _I = 2.7 V	100		
	All others		20		
I _{IL}	I/O ports		-0.25		mA
	All others	V _{CC} = 5.5 V, V _I = 0.4 V	-0.2		
I _{OS} [‡]	V _{CC} = 5.5 V, V _O = 0.5 V	-30	-250		mA
I _{CC}	V _{CC} = 5.5 V, V _I = 0, Outputs open	170	220		mA

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.
switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
f _{max} [§]			R1 = 390 Ω, R2 = 750 Ω, See Figure 1	50			MHz
t _{pd}	I, I/O	O, I/O		8	15		ns
t _{pd}	CLK↑	Q		7	12		ns
t _{en}	OE↓	Q		8	12		ns
t _{dis}	OE↑	Q		7	12		ns
t _{en}	I, I/O	O, I/O		8	15		ns
t _{dis}	I, I/O	O, I/O		8	15		ns

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.[§] Maximum operating frequency and propagation delay are specified for the basic building block. When using feedback, limits must be calculated accordingly.

programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

The TIBPAL16R4-15M with date codes prior to 9616A must be programmed according to programming algorithms/specifications corresponding to the TIBPAL16R4-12C. The TIBPAL16R4-15M with date code 9616A or newer must be programmed according to programming algorithms/specifications corresponding to the TIBPAL16R4-10C.

Regardless of date code, the TIBPAL16L8-15M, TIBPAL16R6-15M, and TIBPAL16R8-15M must be programmed according to programming algorithms/specifications corresponding to the TIBPAL16L8-12C, TIBPAL16R6-12C, and TIBPAL16R8-12C, respectively. Failure to do so may damage the devices.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

**Table 1. Programming Reference Table
(see Note 3)**

DEVICE	DESC SMD NUMBER	FAMILY/PINOUT CODE
TIBPAL16L8-15MJB	5962-8515509RA	9A/17
TIBPAL16L8-15MFKB	5962-85155092A	9A/717
TIBPAL16L8-15MWB	5962-8515509SA	9A/17
TIBPAL16R4-15MJB	5962-8515512RA	A1/24
TIBPAL16R4-15MFKB	5962-85155122A	0A1/724
TIBPAL16R4-15MWB	5962-8515512SA	A1/24
TIBPAL16R6-15MJB	5962-8515511RA	9A/24
TIBPAL16R6-15MFKB	5962-85155112A	9A/724
TIBPAL16R6-15MWB	5962-8515511SA	9A/24
TIBPAL16R8-15MJB	5962-8515510RA	9A/24
TIBPAL16R8-15MFKB	5962-85155102A	9A/724
TIBPAL16R8-15MWB	5962-8515510SA	9A/24

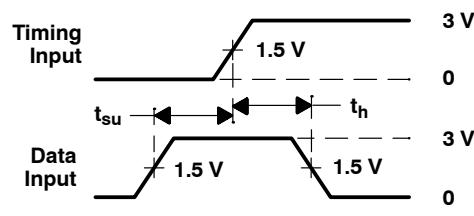
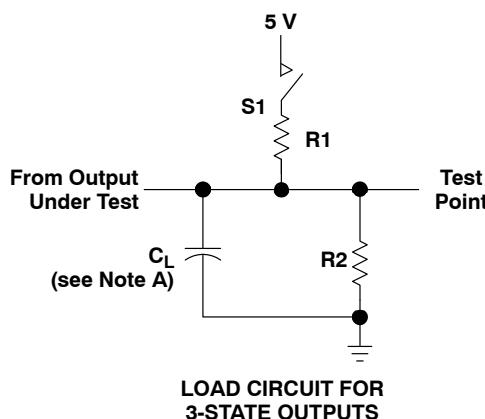
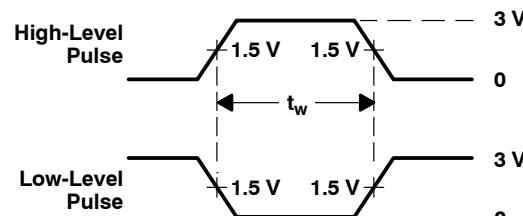
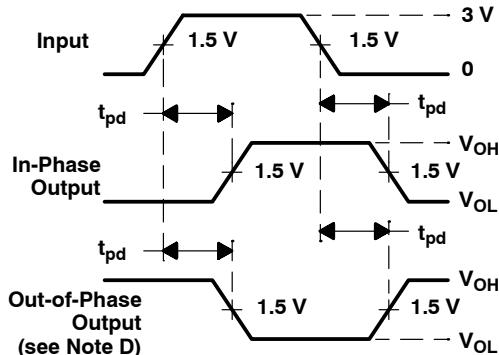
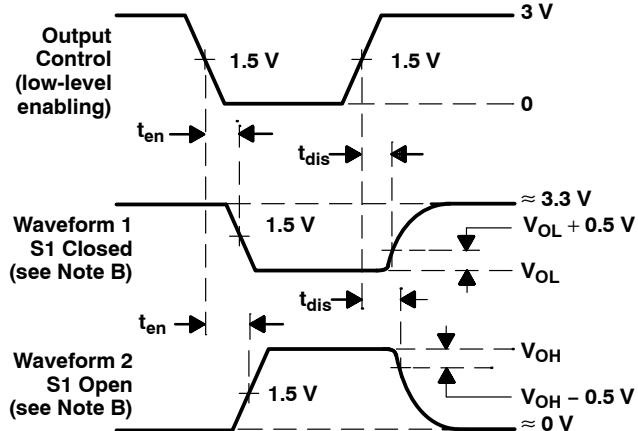
NOTE 3: Programming information for TIBPAL16R4-15M with date codes 9616A or newer. Programming information for TIBPAL16L8-15M, TIBPAL16R6-15M, and TIBPAL16R8-15M regardless of date code.

TIBPAL16L8-15M, TIBPAL16R4-15M

HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS

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PARAMETER MEASUREMENT INFORMATION

VOLTAGE WAVEFORMS
SETUP AND HOLD TIMESVOLTAGE WAVEFORMS
PULSE DURATIONSVOLTAGE WAVEFORMS
PROPAGATION DELAY TIMESVOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses have the following characteristics: PRR \leq 10 MHz, t_r and t_f \leq 2 ns, duty cycle = 50%.
 D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
 E. Equivalent loads may be used for testing.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-85155122A	NRND	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-85155122A TIBPAL16 R4-15MFKB
5962-8515512RA	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512RA TIBPAL16R4-15M JB
5962-8515512SA	NRND	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512SA TIBPAL16R4-15M WB
TIBPAL16L8-15MJ	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	TIBPAL16L8-15M J
TIBPAL16L8-15MJ.A	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	TIBPAL16L8-15M J
TIBPAL16R4-15MFKB	NRND	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-85155122A TIBPAL16 R4-15MFKB
TIBPAL16R4-15MFKB.A	NRND	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-85155122A TIBPAL16 R4-15MFKB
TIBPAL16R4-15MJB	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512RA TIBPAL16R4-15M JB
TIBPAL16R4-15MJB.A	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512RA TIBPAL16R4-15M JB
TIBPAL16R4-15MWB	NRND	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512SA TIBPAL16R4-15M WB
TIBPAL16R4-15MWB.A	NRND	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8515512SA TIBPAL16R4-15M WB

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

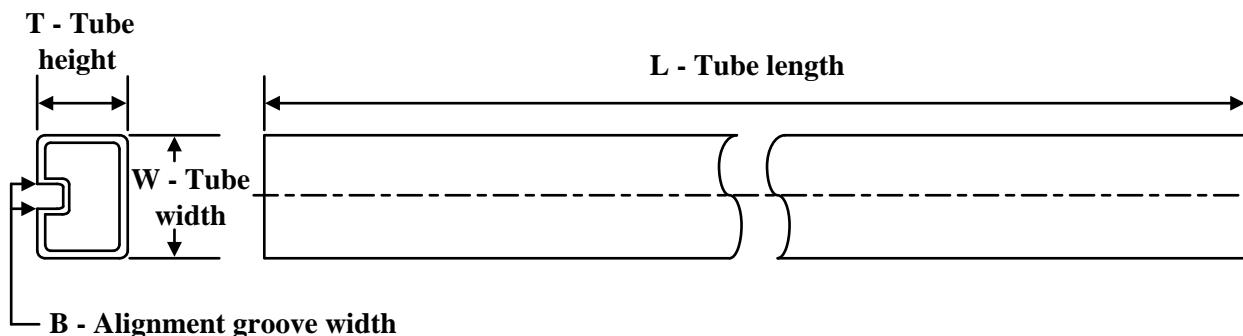
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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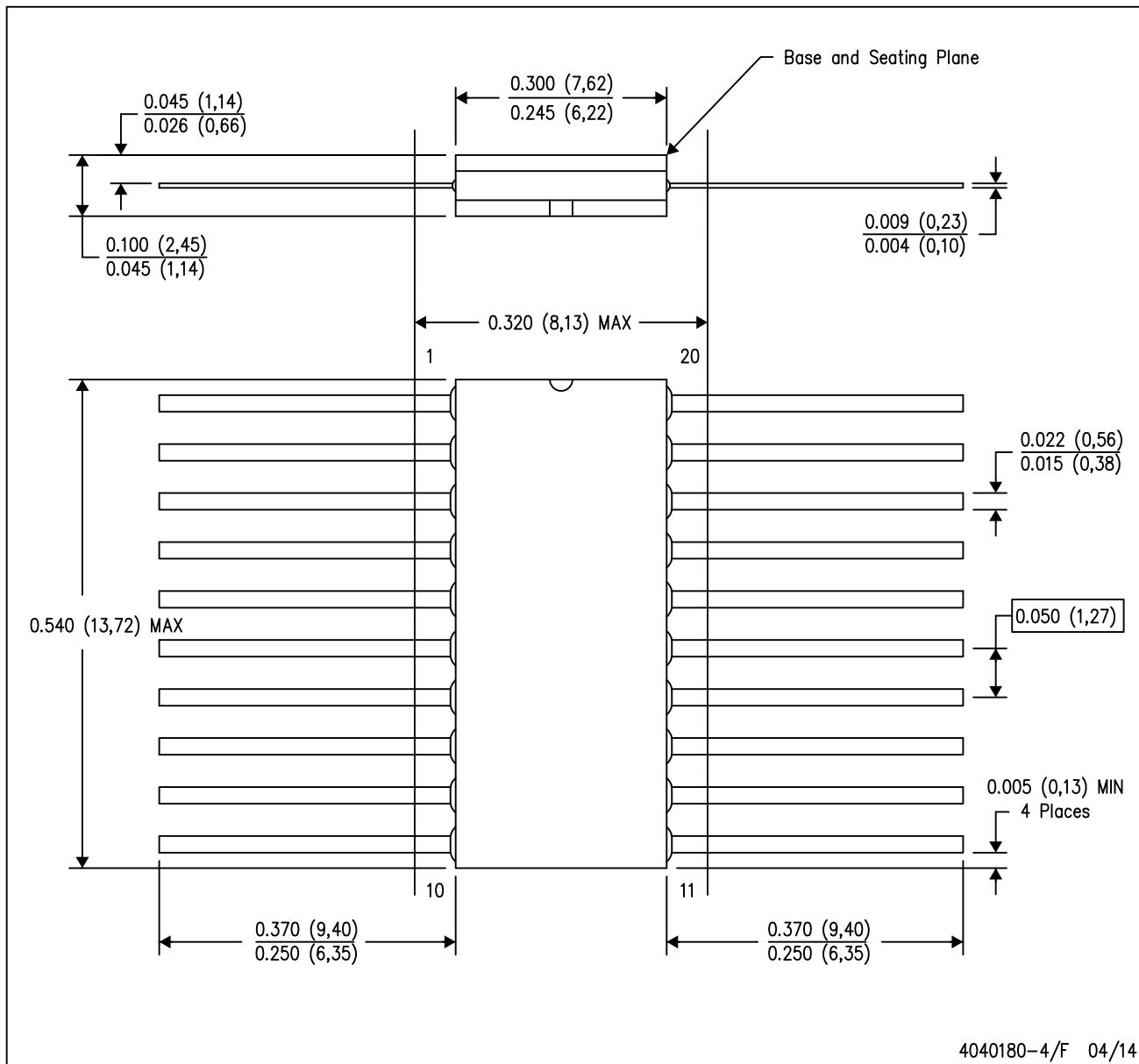
TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-85155122A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8515512SA	W	CFP	20	25	506.98	26.16	6220	NA
TIBPAL16R4-15MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TIBPAL16R4-15MFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TIBPAL16R4-15MWB	W	CFP	20	25	506.98	26.16	6220	NA
TIBPAL16R4-15MWB.A	W	CFP	20	25	506.98	26.16	6220	NA

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



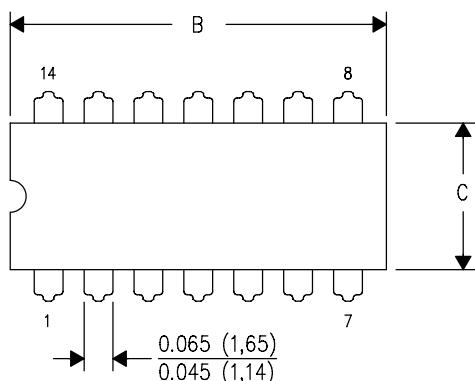
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20

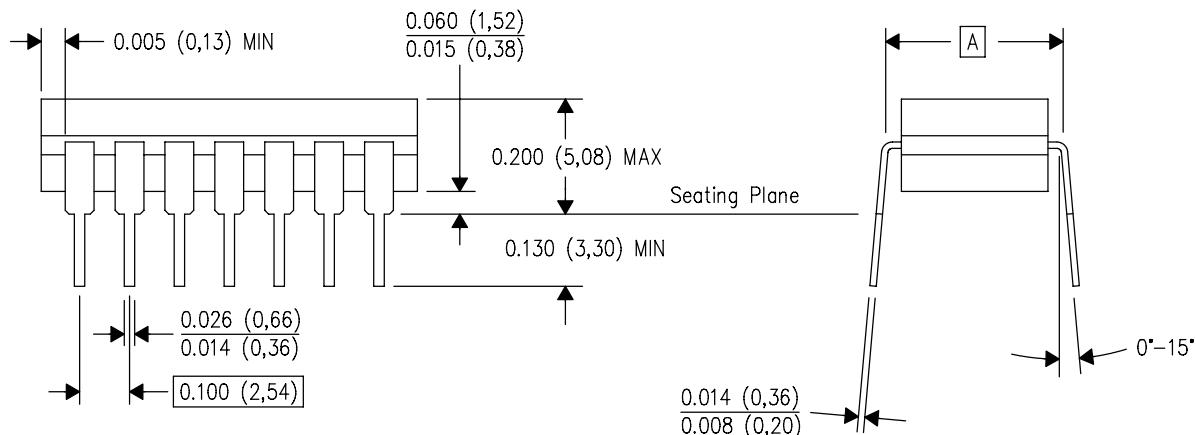
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

GENERIC PACKAGE VIEW

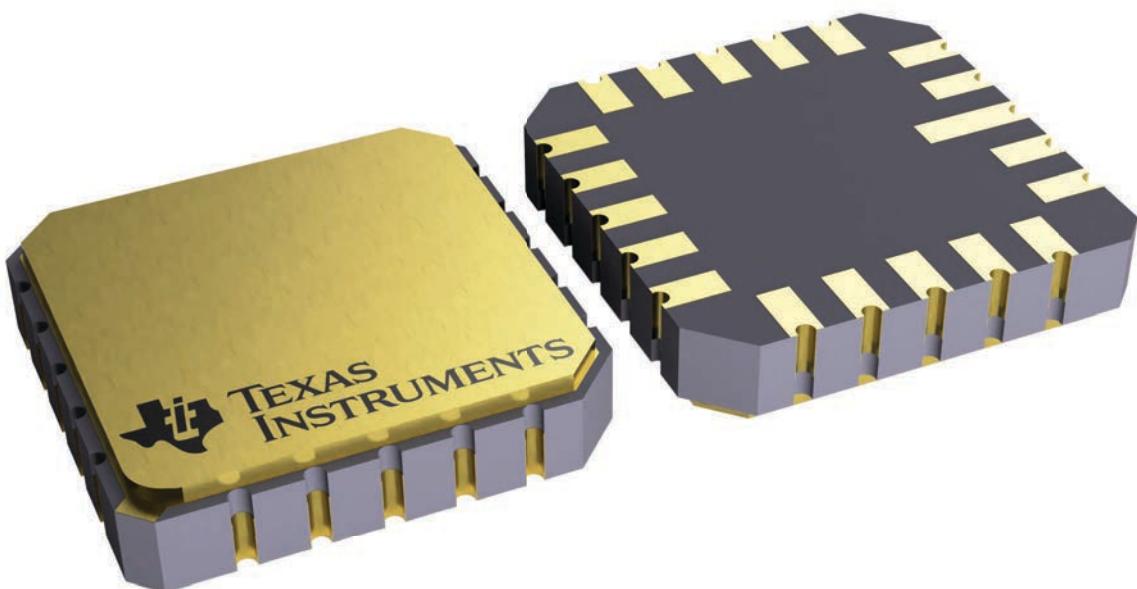
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



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